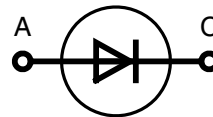
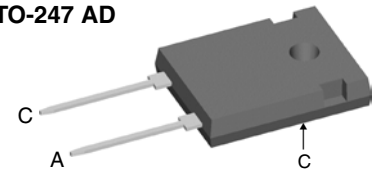


Fast Recovery Epitaxial Diode (FRED)

$I_{FAVM} = 109 \text{ A}$
 $V_{RRM} = 1200 \text{ V}$
 $t_{rr} = 40 \text{ ns}$

| V_{RSM} | V_{RRM} | Type |
|-----------|-----------|--------------|
| V | V | |
| 1200 | 1200 | DSEI 120-12A |


TO-247 AD


A = Anode, C = Cathode

| Symbol | Conditions | Maximum Ratings | |
|---------------|--|-----------------|------------------|
| I_{FRMS} | $T_{VJ} = T_{VJM}$ | 100 | A |
| I_{FAVM} ① | $T_C = 60^\circ\text{C}$; rectangular, $d = 0.5$ | 109 | A |
| I_{FAV} ② | $T_C = 95^\circ\text{C}$; rectangular, $d = 0.5$ | 75 | A |
| I_{FRM} | $t_p < 10 \mu\text{s}$; rep. rating, pulse width limited by T_{VJM} | 1200 | A |
| I_{FSM} | $T_{VJ} = 45^\circ\text{C}$; $t = 10 \text{ ms}$ (50 Hz), sine $t = 8.3 \text{ ms}$ (60 Hz), sine | 600 | A |
| | | 660 | A |
| | $T_{VJ} = 150^\circ\text{C}$; $t = 10 \text{ ms}$ (50 Hz), sine $t = 8.3 \text{ ms}$ (60 Hz), sine | 540 | A |
| | | 600 | A |
| I^2t | $T_{VJ} = 45^\circ\text{C}$; $t = 10 \text{ ms}$ (50 Hz), sine $t = 8.3 \text{ ms}$ (60 Hz), sine | 1800 | A ² s |
| | | 1800 | A ² s |
| | $T_{VJ} = 150^\circ\text{C}$; $t = 10 \text{ ms}$ (50 Hz), sine $t = 8.3 \text{ ms}$ (60 Hz), sine | 1450 | A ² s |
| | | 1500 | A ² s |
| T_{VJ} | | -40...+150 | °C |
| T_{VJM} | | 150 | °C |
| T_{stg} | | -40...+150 | °C |
| P_{tot} | $T_C = 25^\circ\text{C}$ | 357 | W |
| M_d | mounting torque | 0.8...1.2 | Nm |
| Weight | typical | 6 | g |

Features

- International standard package JEDEC TO-247 AD
- Planar passivated chips
- Very short recovery time
- Extremely low switching losses
- Low I_{RM} -values
- Soft recovery behaviour
- Epoxy meets UL 94V-0

Applications

- Antiparallel diode for high frequency switching devices
- Anti saturation diode
- Snubber diode
- Free wheeling diode in converters and motor control circuits
- Rectifiers in switch mode power supplies (SMPS)
- Inductive heating and melting
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders

Advantages

- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching
- Low losses
- Operating at lower temperature or space saving by reduced cooling

| Symbol | Conditions | Characteristic Values | | |
|------------|---|-----------------------|------|-----|
| | | typ. | max. | |
| I_R | $V_R = V_{RRM}$ $T_{VJ} = 25^\circ\text{C}$ | | 3 | mA |
| | $V_R = 0.8 \cdot V_{RRM}$ $T_{VJ} = 25^\circ\text{C}$ | | 1.5 | mA |
| | $V_R = 0.8 \cdot V_{RRM}$ $T_{VJ} = 125^\circ\text{C}$ | | 20 | mA |
| V_F | $I_F = 70 \text{ A}$ $T_{VJ} = 150^\circ\text{C}$ $T_{VJ} = 25^\circ\text{C}$ | | 1.55 | V |
| | | | 1.8 | V |
| V_{T0} | for power-loss calculations only | | 1.2 | V |
| r_T | $T_{VJ} = T_{VJM}$ | | 4.6 | mΩ |
| R_{thJC} | (version A) | | 0.35 | K/W |
| R_{thCH} | | 0.25 | | K/W |
| R_{thJA} | | | 35 | K/W |
| t_{rr} | $I_F = 1 \text{ A}$; $-di/dt = 200 \text{ A}/\mu\text{s}$; $V_R = 30 \text{ V}$; $T_{VJ} = 25^\circ\text{C}$ | 40 | 60 | ns |
| I_{RM} | $V_R = 350 \text{ V}$; $I_F = 75 \text{ A}$; $-di_F/dt = 200 \text{ A}/\mu\text{s}$ $L \leq 0.05 \mu\text{H}$; $T_{VJ} = 100^\circ\text{C}$ | 25 | 30 | A |

① Chip capability, ② limited to 70 A by leads Data according to IEC 60747

IXYS reserves the right to change limits, test conditions and dimensions.

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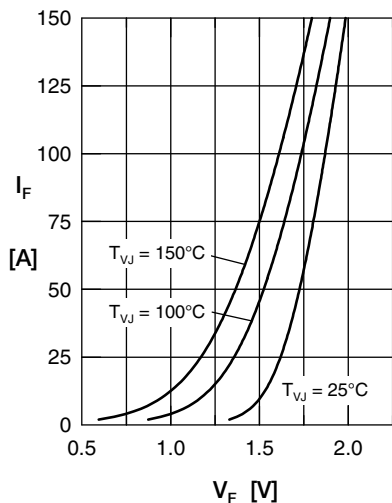


Fig. 1 Forward current I_F vs. V_F

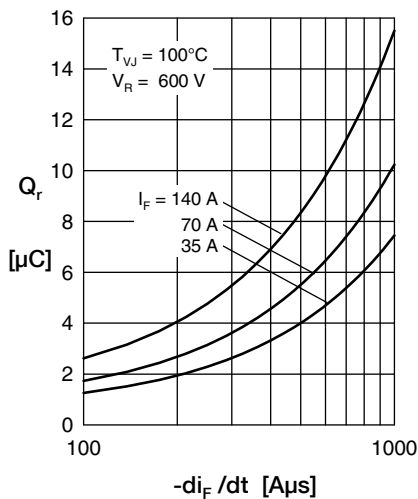


Fig. 2 Reverse recovery charge Q_r versus $-di_F/dt$

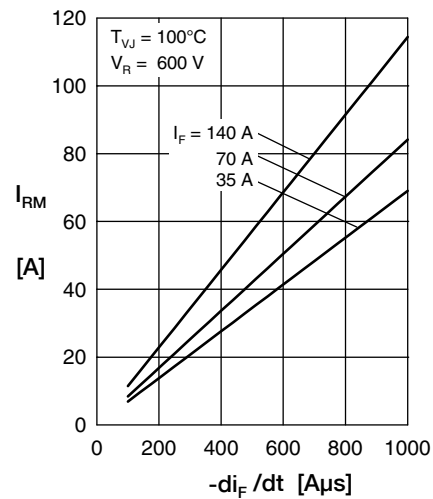


Fig. 3 Peak reverse current I_{RM} versus $-di_F/dt$

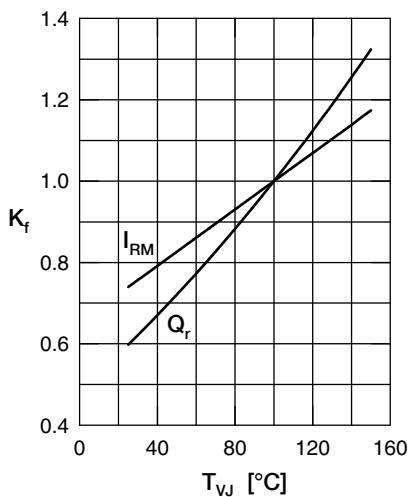


Fig. 4 Dynamic parameters Q_r, I_{RM} versus T_{VJ}

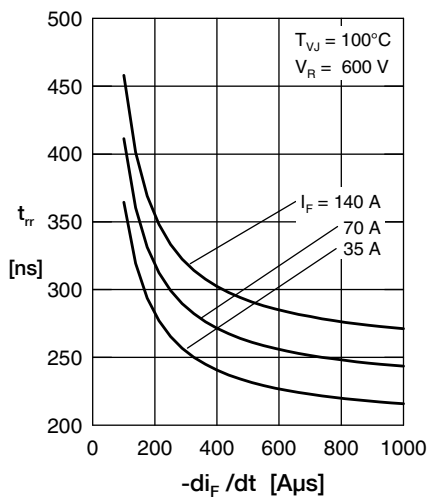


Fig. 5 Recovery time t_{rr} versus $-di_F/dt$

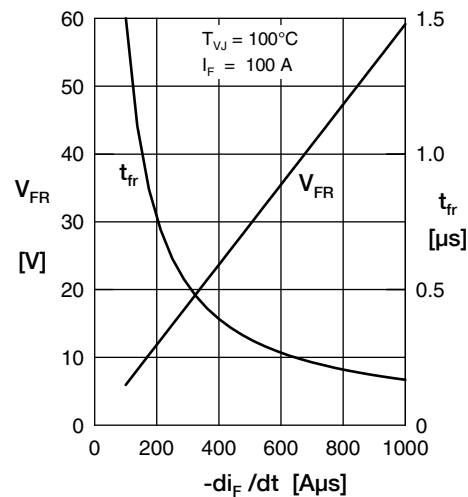


Fig. 6 Peak forward voltage V_{FR} and t_{fr} versus $-di_F/dt$

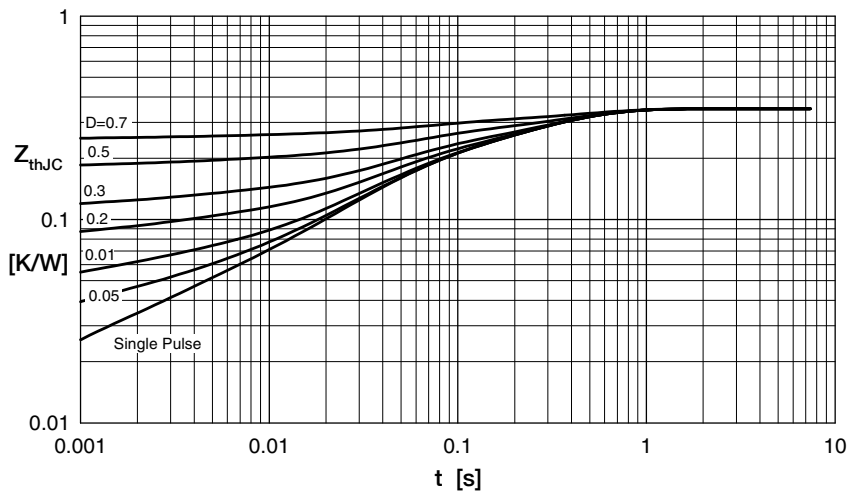
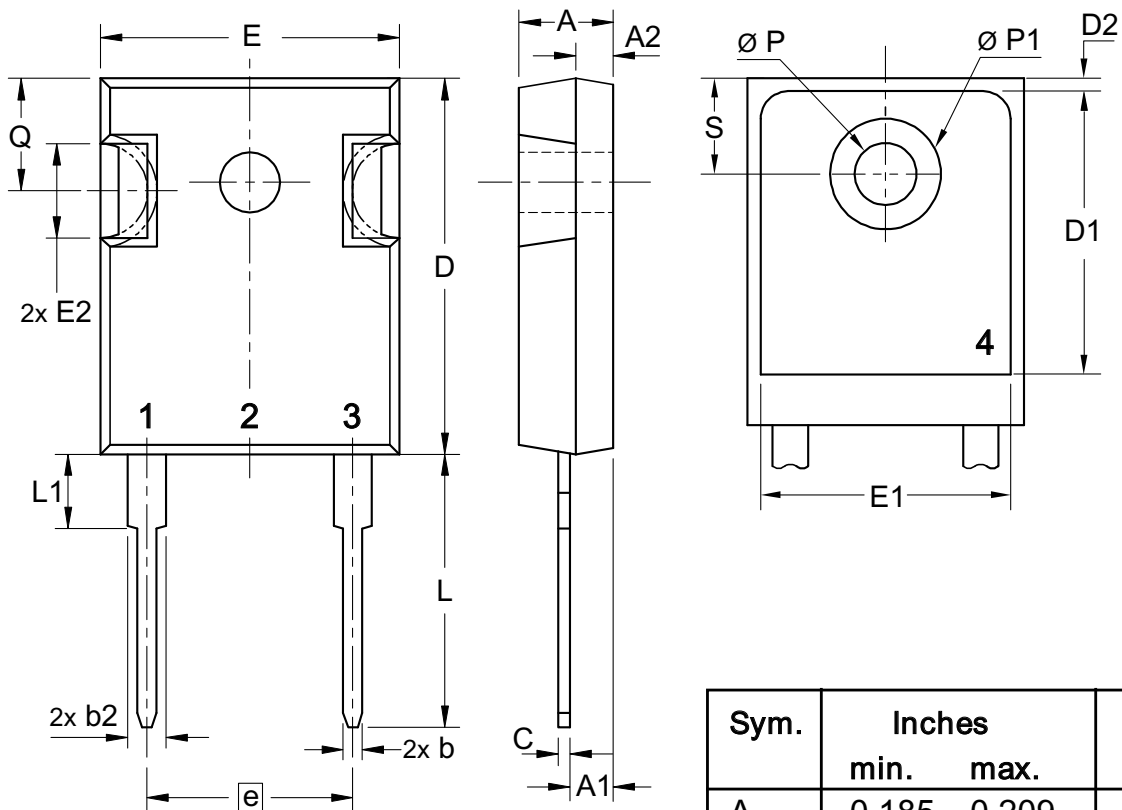


Fig. 7 Transient thermal resistance junction to case at various duty cycles

Constants for Z_{thJC} calculation:

| i | R_{thi} (K/W) | t_i (s) |
|---|-----------------|-----------|
| 1 | 0.017 | 0.00038 |
| 2 | 0.0184 | 0.0026 |
| 3 | 0.1296 | 0.0387 |
| 4 | 0.185 | 0.274 |

Dimensions TO-247 AD



| Sym. | Inches | | Millimeter | |
|------|-----------|-------|------------|-------|
| | min. | max. | min. | max. |
| A | 0.185 | 0.209 | 4.70 | 5.30 |
| A1 | 0.087 | 0.102 | 2.21 | 2.59 |
| A2 | 0.059 | 0.098 | 1.50 | 2.49 |
| D | 0.819 | 0.845 | 20.79 | 21.45 |
| E | 0.610 | 0.640 | 15.48 | 16.24 |
| E2 | 0.170 | 0.216 | 4.31 | 5.48 |
| e | 0.430 BSC | | 10.92 BSC | |
| L | 0.780 | 0.800 | 19.80 | 20.30 |
| L1 | - | 0.177 | - | 4.49 |
| Ø P | 0.140 | 0.144 | 3.55 | 3.65 |
| Q | 0.212 | 0.244 | 5.38 | 6.19 |
| S | 0.242 BSC | | 6.14 BSC | |
| b | 0.039 | 0.055 | 0.99 | 1.40 |
| b2 | 0.065 | 0.094 | 1.65 | 2.39 |
| b4 | 0.102 | 0.135 | 2.59 | 3.43 |
| c | 0.015 | 0.035 | 0.38 | 0.89 |
| D1 | 0.515 | - | 13.07 | - |
| D2 | 0.020 | 0.053 | 0.51 | 1.35 |
| E1 | 0.530 | - | 13.45 | - |
| Ø P1 | - | 0.29 | - | 7.39 |

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